

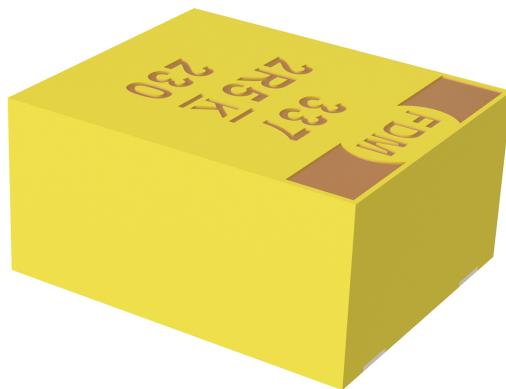
## Overview

The KEMET T428 Series was developed to provide the volumetric efficiency of a conformally coated capacitor in a pick-and-place friendly molded package. The planarity of the molded package eliminates the “drops” associated with the conformally coated tantalum surface mount devices. This new package

design offers the highest CV/cc of any molded leadframe product. In addition, the facedown construction offers higher power ratings per cc. The robust design features and testing protocol make this part suitable for application in the telecommunications, industrial, military and aerospace markets.

## Benefits

- High CV/cc
- Taped and reeled per EIA 481
- SnPb termination finish
- Laser-marked case
- 100% surge current test available
- Halogen-free epoxy
- Capacitance values of 15 to 470  $\mu$ F
- Tolerances of  $\pm 5\%$ ,  $\pm 10\%$ , and  $\pm 20\%$
- Voltage rating of 4 to 50 VDC
- Extended range values
- Pick-and-place friendly
- RoHS Compliant and lead-free terminations available
- Operating temperature range of  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$



## Applications

Typical applications include decoupling and filtering in telecommunications, computer, industrial, defense and aerospace applications.

## Environmental Compliance

RoHS Compliant (6/6) according to Directive 2002/95/EC when ordered with 100% Sn solder.

## K-SIM

For a detailed analysis of specific part numbers, please visit [ksim.kemet.com](http://ksim.kemet.com) to access KEMET's K-SIM software. KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels.

## Ordering Information

| T               | 428  | P         | 227  | K                               | 006  | A                               | H  | 61  | 10  |
|-----------------|--|-----------|--|---------------------------------|--|---------------------------------|--|---|---|
| Capacitor Class | Series   | Case Size | Capacitance Code (pF)  | Capacitance Tolerance           | Rated Voltage (VDC)  | Failure Rate/Design             | Termination Finish   | Surge   | ESR   |
| T = Tantalum    | High Volumetric Efficiency Facedown Hi-Rel MnO <sub>2</sub> COTS | P         | First two digits represent significant figures. Third digit specifies number of zeros. | J = ±5%<br>K = ±10%<br>M = ±20% | 004 = 4<br>006 = 6.3<br>010 = 10<br>016 = 16<br>020 = 20<br>025 = 25<br>035 = 35<br>050 = 50 | A = N/A<br>B = 0.1%/1,000 hours | H = Standard solder coated (SnPb 5% Pb)<br>T = 100% tin (Sn) | 61 = None<br>62 = 10 cycles, 25°C<br>63 = 10 cycles, -55°C and 85°C | 10 = Standard<br>20 = Low<br>30 = Ultra-low |

## Performance Characteristics

| Item                    | Performance Characteristics                            |
|-------------------------|--|
| Operating Temperature   | -55°C to 125°C   |
| Rated Capacitance Range | 15 – 470 µF @ 120 Hz/25°C                              |
| Capacitance Tolerance   | J Tolerance (5%), K Tolerance (10%), M Tolerance (20%) |
| Rated Voltage Range     | 4 – 50 V   |
| DF (120 Hz)             | Refer to Part Number Electrical Specification Table    |
| ESR (100 kHz)           | Refer to Part Number Electrical Specification Table    |
| Leakage Current         | ≤ 0.01 CV (µA) at rated voltage after 5 minutes        |

## Qualification

| Test  | Condition   | Characteristics |                              |       |          |
|---|---|-----------------|------------------------------|-------|----------|
| Endurance   | 85°C @ rated voltage, 2,000 hours<br>125°C @ 2/3 rated voltage, 2,000 hours   | Δ C/C           | Within ±10% of initial value |       |          |
|   |   | DF              | Within initial limits        |       |          |
|   |   | DCL             | Within 1.25 x initial limit  |       |          |
|   |   | ESR             | Within initial limits        |       |          |
| Storage Life  | 125°C @ 0 volts, 2,000 hours  | Δ C/C           | Within ±10% of initial value |       |          |
|   |   | DF              | Within initial limits        |       |          |
|   |   | DCL             | Within 1.25 x initial limit  |       |          |
|   |   | ESR             | Within initial limits        |       |          |
| Thermal Shock   | MIL-STD-202, Method 107, Condition B, mounted,<br>-55°C to 125°C, 1,000 cycles  | Δ C/C           | Within ±5% of initial value  |       |          |
|   |   | DF              | Within initial limits        |       |          |
|   |   | DCL             | Within 1.25 x initial limit  |       |          |
|   |   | ESR             | Within initial limits        |       |          |
| Temperature Stability                                 | Extreme temperature exposure at a<br>succession of continuous steps at +25°C,<br>-55°C, +25°C, +85°C, +125°C, +25°C       | +25°C           | -55°C                        | +85°C | +125°C   |
|   |   | Δ C/C           | IL*                          | ±10%  | ±10%     |
|   |   | DF              | IL                           | IL    | 1.5 x IL |
|   |   | DCL             | IL                           | n/a   | 10 x IL  |
| Surge Voltage   | 85°C, 1.32 x rated voltage 1,000 cycles<br>(125°C, 1.2 x rated voltage)   | Δ C/C           | Within ±5% of initial value  |       |          |
|   |   | DF              | Within initial limits        |       |          |
|   |   | DCL             | Within initial limits        |       |          |
|   |   | ESR             | Within initial limits        |       |          |
| Mechanical Shock/Vibration                            | MIL-STD-202, Method 213, Condition I, 100 G peak<br>MIL-STD-202, Method 204, Condition D, 10 Hz to 2,000 Hz,<br>20 G peak | Δ C/C           | Within ±10% of initial value |       |          |
|   |   | DF              | Within initial limits        |       |          |
|   |   | DCL             | Within initial limits        |       |          |
| Additional Qualification Tests<br>per MIL-PRF-55365/8 | Please contact KEMET for more information.  |                 |                              |       |          |

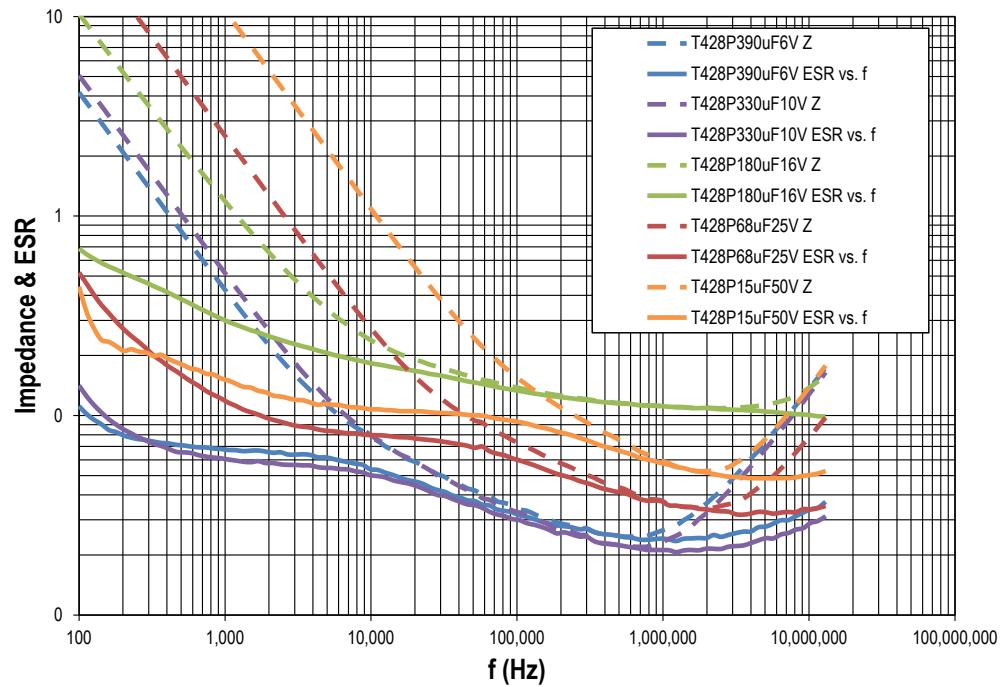
\*IL = Initial limit

## Certification

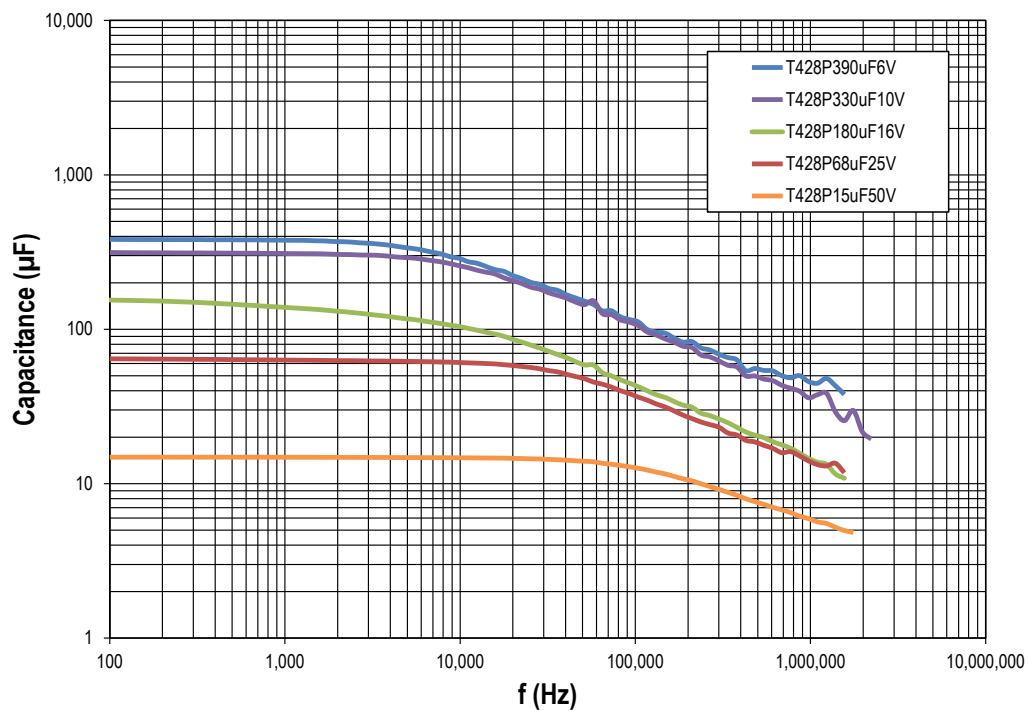
MIL-PRF-55365/8

## Electrical Characteristics

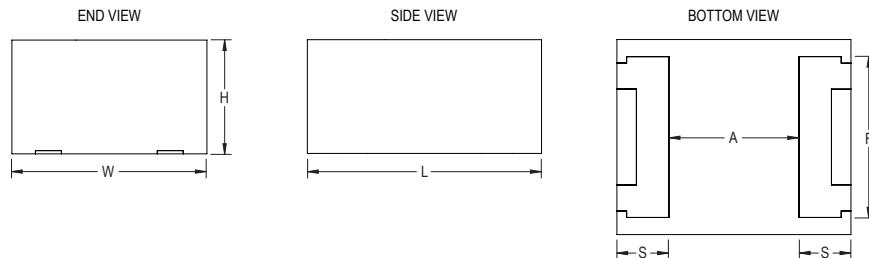
Impedance & ESR vs. Frequency



Capacitance vs. Frequency



## Dimensions – Millimeters



| Case Size | Component |        |        |         |         |         | Total Weight |
|-----------|-----------|--------|--------|---------|---------|---------|--------------|
|           | L Max     | W ±0.3 | H ±0.3 | F ±0.20 | S ±0.20 | A (Nom) |              |
| 7360-38   | 7.2       | 6.0    | 3.5    | 4.95    | 1.6     | 3.8     | 0.86         |

These weights are provided as reference. If exact weights are needed, please contact your KEMET Sales Representative

**Table 1 – Ratings & Part Number Reference**

| Rated Voltage | Rated Cap | Case Code/<br>Case Size | KEMET Part Number            | DC Leakage                    | DF                       | Standard ESR               | Low ESR                    | Ultra-Low ESR             | Maximum Operating Temp | MSL                 |
|---------------|-----------|-------------------------|------------------------------|-------------------------------|--------------------------|----------------------------|----------------------------|---------------------------|------------------------|---------------------|
| VDC @ 85°C    | µF        | KEMET/EIA               | (See below for part options) | µA @ +20°C Maximum/ 5 Minutes | % @ +20°C 120 Hz Maximum | mΩ @ +20°C 100 kHz Maximum | mΩ @ +20°C 100 kHz Maximum | Ω @ +20°C 100 kHz Maximum | °C                     | Reflow Temp ≤ 260°C |
| 4             | 470       | P/7360-38               | T428P477(1)004(2)(3)(4)(5)   | 18.8                          | 10.0                     | 130                        | 45                         | NA                        | 125                    | 1                   |
| 6.3           | 390       | P/7360-38               | T428P397(1)006(2)(3)(4)(5)   | 24.6                          | 8.0                      | 130                        | 45                         | NA                        | 125                    | 1                   |
| 6.3           | 470       | P/7360-38               | T428P477(1)006(2)(3)(4)(5)   | 29.6                          | 10.0                     | 120                        | 50                         | NA                        | 125                    | 1                   |
| 10            | 330       | P/7360-38               | T428P337(1)010(2)(3)(4)(5)   | 33.0                          | 8.0                      | 130                        | 45                         | NA                        | 125                    | 1                   |
| 16            | 180       | P/7360-38               | T428P187(1)016(2)(3)(4)(5)   | 28.8                          | 8.0                      | 130                        | 55                         | NA                        | 125                    | 1                   |
| 16            | 220       | P/7360-38               | T428P227(1)016(2)(3)(4)(5)   | 35.2                          | 8.0                      | 120                        | 55                         | NA                        | 125                    | 1                   |
| 20            | 150       | P/7360-38               | T428P157(1)020(2)(3)(4)(5)   | 30.0                          | 8.0                      | 140                        | 100                        | NA                        | 125                    | 1                   |
| 25            | 68        | P/7360-38               | T428P686(1)025(2)(3)(4)(5)   | 17.0                          | 6.0                      | 200                        | 95                         | NA                        | 125                    | 1                   |
| 35            | 22        | P/7360-38               | T428P226(1)035(2)(3)(4)(5)   | 7.7                           | 6.0                      | 280                        | 220                        | NA                        | 125                    | 1                   |
| 50            | 15        | P/7360-38               | T428P156(1)050(2)(3)(4)(5)   | 7.5                           | 6.0                      | 400                        | 350                        | NA                        | 125                    | 1                   |

(1) To complete KEMET part number, insert J for ±5%, K for ±10% and M for ±20%. Designates capacitance tolerance.

(2) To complete KEMET part number, insert B (0.1%/1,000 hours) or A = N/A.

(3) To complete KEMET part number, insert H = solder plated or T = 100% tin (Sn). Designates termination finish.

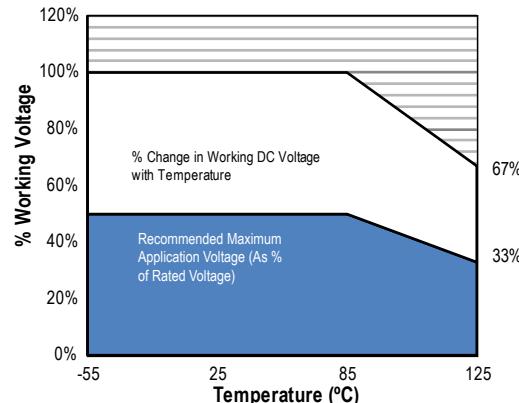
(4) To complete KEMET part number, insert 61 = none, 62 = 10 cycles +25°C or 63 = 10 cycles -55°C +85°C. Designates surge current option.

(5) To complete KEMET part number, insert 10 = standard, 20 = low or 30 = ultra-low. Designates ESR option.

Please refer to Ordering Information for additional details.

## Recommended Voltage Derating Guidelines

|   | -55°C to 85°C | 85°C to 125°C |
|---|---------------|---------------|
| % Change in Working DC Voltage with Temperature | $V_R$         | 67% of $V_R$  |
| Recommended Maximum Application Voltage         | 50% of $V_R$  | 33% of $V_R$  |



## Ripple Current/Ripple Voltage

Permissible AC ripple voltage and current are related to equivalent series resistance (ESR) and the power dissipation capabilities of the device. Permissible AC ripple voltage which may be applied is limited by two criteria:

1. The positive peak AC voltage plus the DC bias voltage, if any, must not exceed the DC voltage rating of the capacitor.
2. The negative peak AC voltage in combination with bias voltage, if any, must not exceed the allowable limits specified for reverse voltage. See the Reverse Voltage section for allowable limits.

The maximum power dissipation by case size can be determined using the table at right. The maximum power dissipation rating stated in the table must be reduced with increasing environmental operating temperatures. Refer to the table below for temperature compensation requirements.

| KEMET Case Code | EIA Case Code | Maximum Power Dissipation (P <sub>max</sub> ) mWatts @ 25°C w/+20°C Rise |
|-----------------|---------------|--|
| P               | 7360-38       | 325  |

The maximum power dissipation rating must be reduced with increasing environmental operating temperatures. Refer to the Temperature Compensation Multiplier table for details.

### Temperature Compensation Multipliers for Maximum Ripple Current

| T ≤ 25°C | T ≤ 85°C | T ≤ 125°C |
|----------|----------|-----------|
| 1.00     | 0.90     | 0.40      |

T= Environmental Temperature

Using the P<sub>max</sub> of the device, the maximum allowable rms ripple current or voltage may be determined.

$$I_{(max)} = \sqrt{P_{max}/R}$$

$$E_{(max)} = Z \sqrt{P_{max}/R}$$

I = rms ripple current (amperes)

E = rms ripple voltage (volts)

P<sub>max</sub> = maximum power dissipation (watts)

R = ESR at specified frequency (ohms)

Z = Impedance at specified frequency (ohms)

## Reverse Voltage

Solid tantalum capacitors are polar devices and may be permanently damaged or destroyed if connected with the wrong polarity. The positive terminal is identified on the capacitor body by a stripe, plus in some cases a beveled edge. A small degree of transient reverse voltage is permissible for short periods per the below table. The capacitors should not be operated continuously in reverse mode, even within these limits.

| Temperature | Permissible Transient Reverse Voltage |
|-------------|---------------------------------------|
| 25°C        | 15% of Rated Voltage                  |
| 85°C        | 5% of Rated Voltage                   |
| 125°C       | 1% of Rated Voltage                   |

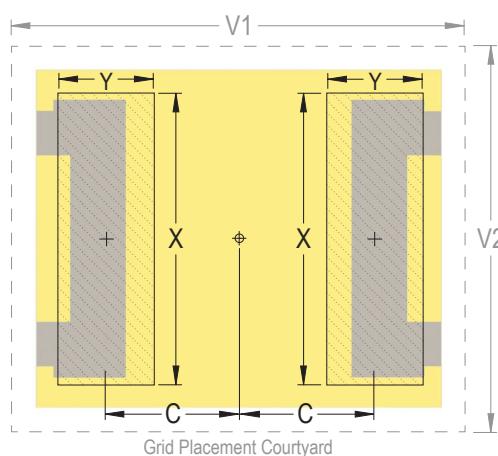
**Table 2 – Land Dimensions/Courtyard**

| KEMET | Metric Size Code | Density Level A: Maximum (Most) Land Protrusion (mm) |      |      |      |      | Density Level B: Median (Nominal) Land Protrusion (mm) |      |      |      |      | Density Level C: Minimum (Least) Land Protrusion (mm) |      |      |      |      |
|-------|------------------|--|------|------|------|------|--|------|------|------|------|---|------|------|------|------|
|       |                  | X  | Y    | C    | V1   | V2   | X  | Y    | C    | V1   | V2   | X   | Y    | C    | V1   | V2   |
| P     | 7360-38          | 5.25   | 1.80 | 2.35 | 8.50 | 7.30 | 5.15   | 1.70 | 2.35 | 8.00 | 6.80 | 5.05  | 1.60 | 2.35 | 7.70 | 6.50 |

**Density Level A:** For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.

**Density Level B:** For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes.

**Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).



## Soldering Process

KEMET's families of surface mount capacitors are compatible with wave (single or dual), convection, IR, or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020D standard for moisture sensitivity testing. The devices can safely withstand a maximum of three reflow passes at these conditions.

Please note that although the X/7343-43 case size can withstand wave soldering, the tall profile (4.3 mm maximum) dictates care in wave process development.

Hand soldering should be performed with care due to the difficulty in process control. If performed, care should be taken to avoid contact of the soldering iron to the molded case. The iron should be used to heat the solder pad, applying solder between the pad and the termination, until reflow occurs. Once reflow occurs, the iron should be removed immediately. "Wiping" the edges of a chip and heating the top surface is not recommended.

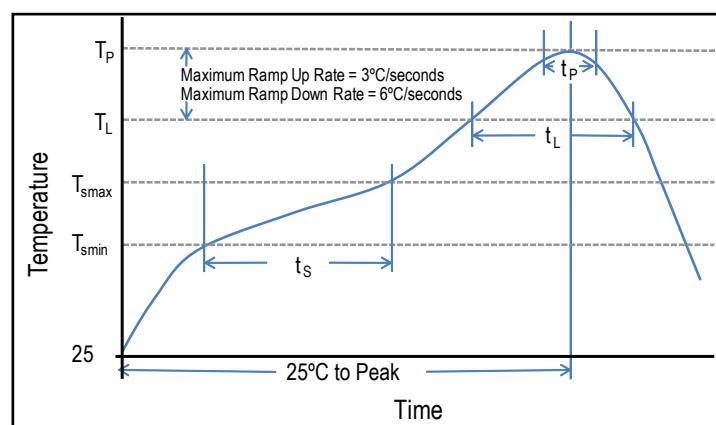
During typical reflow operations, a slight darkening of the gold-colored epoxy may be observed. This slight darkening is normal and not harmful to the product. Marking permanency is not affected by this change.

| Profile Feature                                       | SnPb Assembly       | Pb-Free Assembly    |
|---|---------------------|---------------------|
| Preheat/Soak  |                     |                     |
| Temperature Minimum ( $T_{smin}$ )                    | 100°C               | 150°C               |
| Temperature Maximum ( $T_{smax}$ )                    | 150°C               | 200°C               |
| Time ( $t_s$ ) from $T_{smin}$ to $T_{smax}$          | 60 – 120 seconds    | 60 – 120 seconds    |
| Ramp-up Rate ( $T_L$ to $T_P$ )                       | 3°C/seconds maximum | 3°C/seconds maximum |
| Liquidous Temperature ( $T_L$ )                       | 183°C               | 217°C               |
| Time Above Liquidous ( $t_L$ )                        | 60 – 150 seconds    | 60 – 150 seconds    |
| Peak Temperature ( $T_P$ )                            | 220°C*<br>235°C**   | 250°C*<br>260°C**   |
| Time within 5°C of Maximum Peak Temperature ( $t_P$ ) | 20 seconds maximum  | 30 seconds maximum  |
| Ramp-down Rate ( $T_P$ to $T_L$ )                     | 6°C/seconds maximum | 6°C/seconds maximum |
| Time 25°C to Peak Temperature                         | 6 minutes maximum   | 8 minutes maximum   |

Note: All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow.

\*Case Size D, E, P, Y, and X

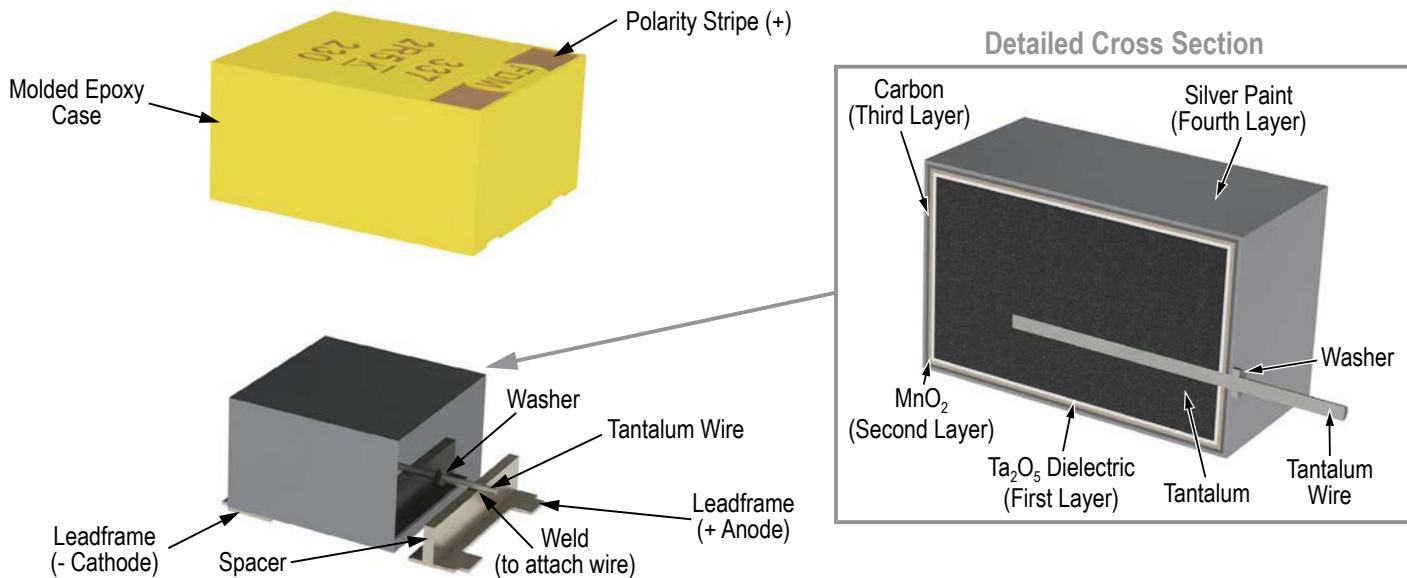
\*\*Case Size A, B, C, H, I, K, M, R, S, T, U, V, W, and Z



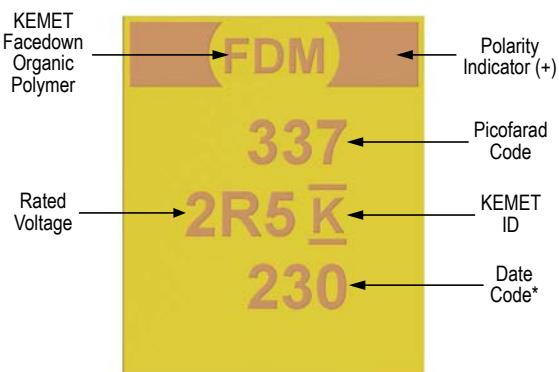
## Storage

Tantalum chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature—reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 60% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulphur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within three years of receipt.

## Construction



## Capacitor Marking

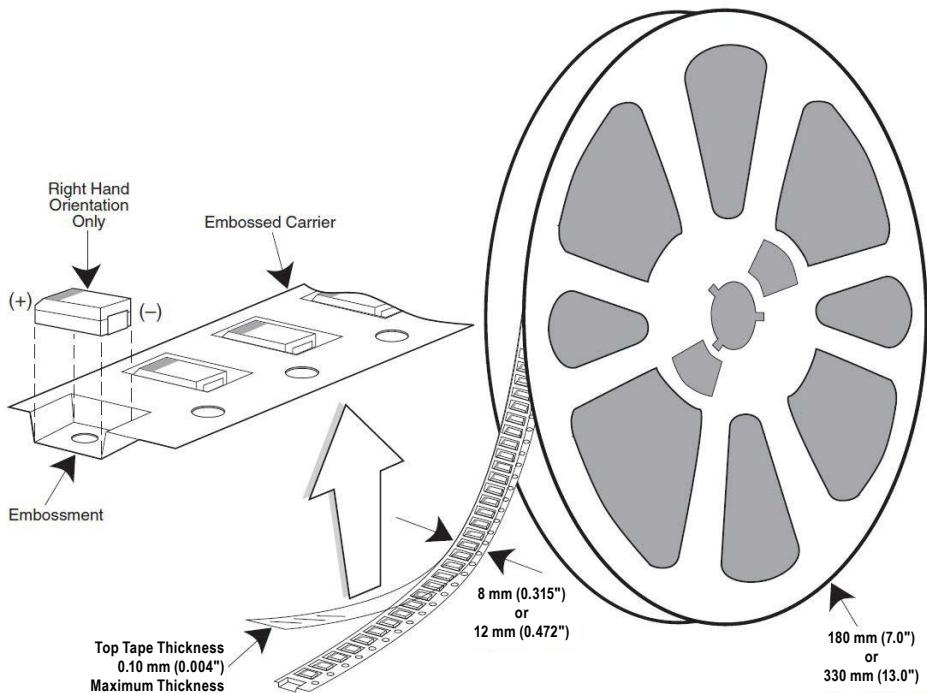


\* 230 = 30<sup>th</sup> week of 2012

| Date Code *  |  |
|--|--|
| 1 <sup>st</sup> digit = Last number of Year                  | 2 = 2012<br>3 = 2013<br>4 = 2014<br>5 = 2015<br>6 = 2016<br>7 = 2017               |
| 2 <sup>nd</sup> and 3 <sup>rd</sup> digit = Week of the Year | 01 = 1 <sup>st</sup> week of the Year to<br>52 = 52 <sup>nd</sup> week of the Year |

## Tape & Reel Packaging Information

KEMET's molded chip capacitor families are packaged in 8 and 12 mm plastic tape on 7" and 13" reels in accordance with *EIA Standard 481: Embossed Carrier Taping of Surface Mount Components for Automatic Handling*. This packaging system is compatible with all tape-fed automatic pick-and-place systems.

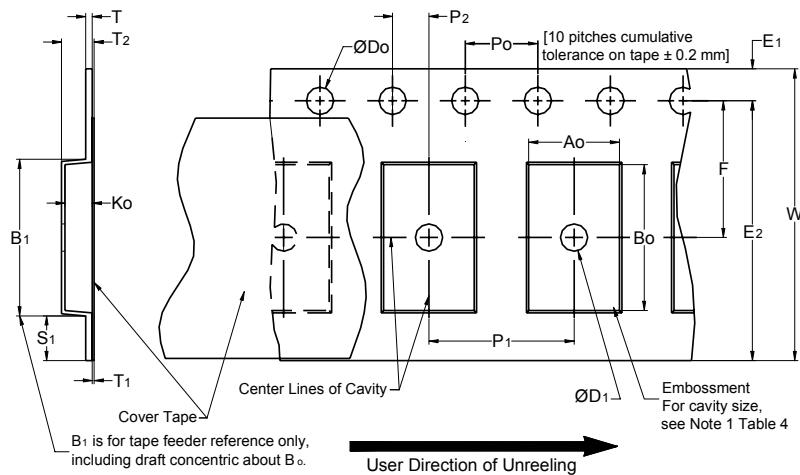


**Table 3 – Packaging Quantity**

| Case Code |         | Tape Width (mm) | 7" Reel* | 13" Reel* |
|-----------|---------|-----------------|----------|-----------|
| KEMET     | EIA     |                 |          |           |
| S         | 3216-12 | 8               | 2,500    | 10,000    |
| T         | 3528-12 | 8               | 2,500    | 10,000    |
| M         | 3528-15 | 8               | 2,000    | 8,000     |
| U         | 6032-15 | 12              | 1,000    | 5,000     |
| L         | 6032-19 | 12              | 1,000    | 3,000     |
| W         | 7343-15 | 12              | 1,000    | 3,000     |
| Z         | 7343-17 | 12              | 1,000    | 3,000     |
| V         | 7343-20 | 12              | 1,000    | 3,000     |
| A         | 3216-18 | 8               | 2,000    | 9,000     |
| B         | 3528-21 | 8               | 2,000    | 8,000     |
| C         | 6032-28 | 12              | 500      | 3,000     |
| D         | 7343-31 | 12              | 500      | 2,500     |
| Q         | 7343-12 | 12              | 1,000    | 3,000     |
| Y         | 7343-40 | 12              | 500      | 2,000     |
| X         | 7343-43 | 12              | 500      | 2,000     |
| E/T428P   | 7360-38 | 12              | 500      | 2,000     |
| H         | 7360-20 | 12              | 1,000    | 2,500     |

\* No C-Spec required for 7" reel packaging. C-7280 required for 13" reel packaging.

## Figure 1 – Embossed (Plastic) Carrier Tape Dimensions



## Table 4 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

| Constant Dimensions — Millimeters (Inches) |                                       |                               |                              |                             |                             |                    |                               |                  |                        |
|--|---------------------------------------|-------------------------------|------------------------------|-----------------------------|-----------------------------|--------------------|-------------------------------|------------------|------------------------|
| Tape Size                                  | D <sub>0</sub>                        | D <sub>1</sub> Minimum Note 1 | E <sub>1</sub>               | P <sub>0</sub>              | P <sub>2</sub>              | R Reference Note 2 | S <sub>1</sub> Minimum Note 3 | T Maximum        | T <sub>1</sub> Maximum |
| 8 mm                                       | 1.5 +0.10/-0.0<br>(0.059 +0.004/-0.0) | 1.0<br>(0.039)                | 1.75 ±0.10<br>(0.069 ±0.004) | 4.0 ±0.10<br>(0.157 ±0.004) | 2.0 ±0.05<br>(0.079 ±0.002) | 25.0<br>(0.984)    | 0.600<br>(0.024)              | 0.600<br>(0.024) | 0.100<br>(0.004)       |
| 12 mm                                      |                                       | 1.5<br>(0.059)                |                              |                             |                             | 30                 |                               |                  |                        |
| 16 mm                                      |                                       |                               |                              |                             | 2.0 ±0.1<br>(0.079 ±0.059)  |                    |                               |                  |                        |

| Variable Dimensions — Millimeters (Inches) |                               |                               |                        |                             |  |                        |                 |  |  |
|--|-------------------------------|-------------------------------|------------------------|-----------------------------|--|------------------------|-----------------|--|--|
| Tape Size                                  | Pitch                         | B <sub>1</sub> Maximum Note 4 | E <sub>2</sub> Minimum | F                           | P <sub>1</sub>   | T <sub>2</sub> Maximum | W Maximum       | A <sub>0</sub> , B <sub>0</sub> & K <sub>0</sub> |  |
| 8 mm                                       | Single (4 mm)                 | 4.35<br>(0.171)               | 6.25<br>(0.246)        | 3.5 ±0.05<br>(0.138 ±0.002) | 2.0 ±0.05 or 4.0 ±0.10<br>(0.079 ±0.002 or 0.157 ±0.004)                         | 2.5<br>(0.098)         | 8.3<br>(0.327)  | Note 5   |  |
| 12 mm                                      | Single (4 mm) & Double (8 mm) | 8.2<br>(0.323)                | 10.25<br>(0.404)       | 5.5 ±0.05<br>(0.217 ±0.002) | 2.0 ±0.05 (0.079 ±0.002) or 4.0 ±0.10 (0.157 ±0.004) or 8.0 ±0.10 (0.315 ±0.004) | 4.6<br>(0.181)         | 12.3<br>(0.484) |  |  |
| 16 mm                                      | Triple (12 mm)                | 12.1<br>(0.476)               | 14.25<br>(0.561)       | 7.5 ±0.10<br>(0.295 ±0.004) | 4.0 ±0.10 (0.157 ±0.004) to 12.0 ±0.10 (0.472 ±0.004)                            | 8.0 (0.315)            | 16.3<br>(0.642) |  |  |

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
2. The tape, with or without components, shall pass around R without damage (see Figure 4).
3. If S<sub>1</sub> < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481-D, paragraph 4.3, section b).
4. B<sub>1</sub> dimension is a reference dimension for tape feeder clearance only.
5. The cavity defined by A<sub>0</sub>, B<sub>0</sub> and K<sub>0</sub> shall surround the component with sufficient clearance that:
  - (a) the component does not protrude above the top surface of the carrier tape.
  - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
  - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 2).
  - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 mm and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 3).
  - (e) see Addendum in EIA Standard 481-D for standards relating to more precise taping requirements.

## Packaging Information Performance Notes

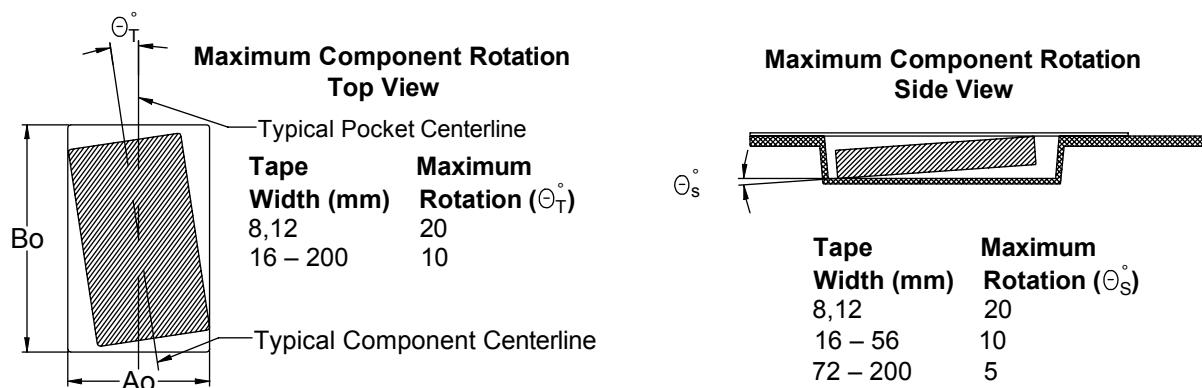
- Cover Tape Break Force:** 1.0 Kg minimum.
- Cover Tape Peel Strength:** The total peel strength of the cover tape from the carrier tape shall be:

| Tape Width   | Peel Strength                    |
|--------------|----------------------------------|
| 8 mm         | 0.1 to 1.0 Newton (10 to 100 gf) |
| 12 and 16 mm | 0.1 to 1.3 Newton (10 to 130 gf) |

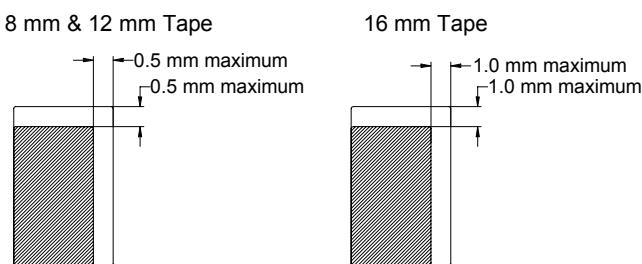
The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.

- Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. Refer to *EIA Standards 556 and 624*.

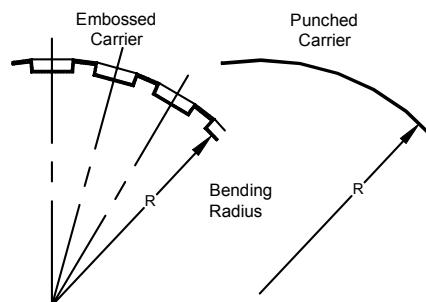
**Figure 2 – Maximum Component Rotation**



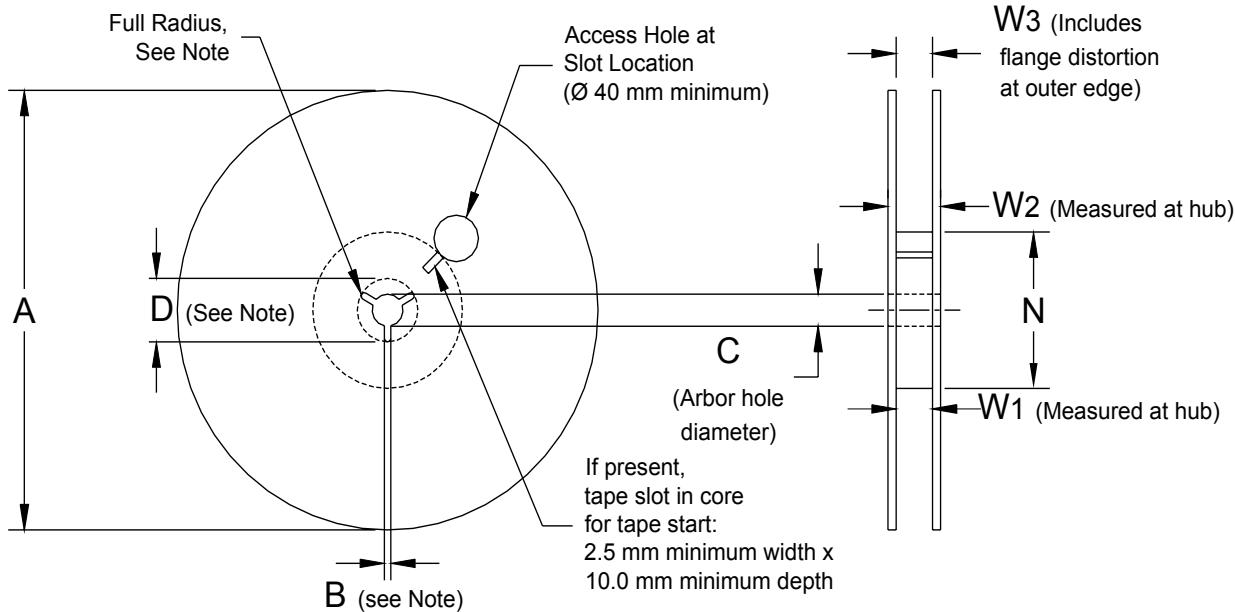
**Figure 3 – Maximum Lateral Movement**



**Figure 4 – Bending Radius**



## Figure 5 – Reel Dimensions



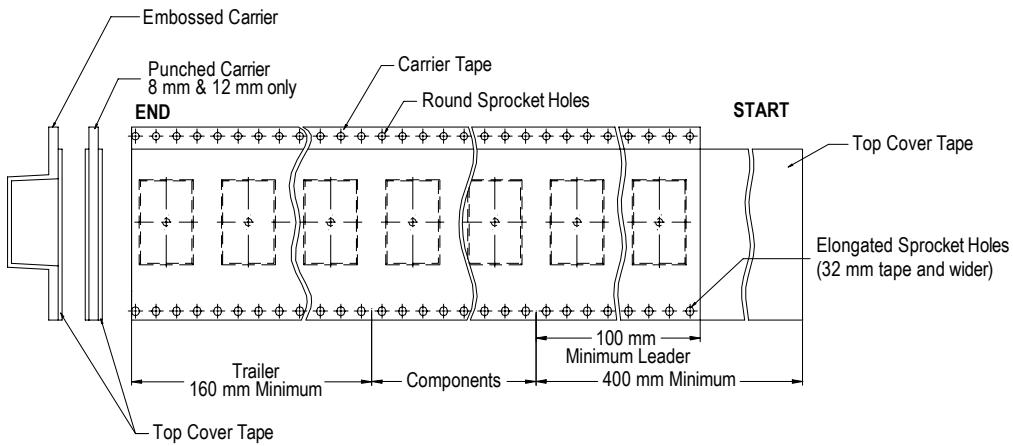
Note: Drive spokes optional; if used, dimensions B and D shall apply.

## Table 5 – Reel Dimensions

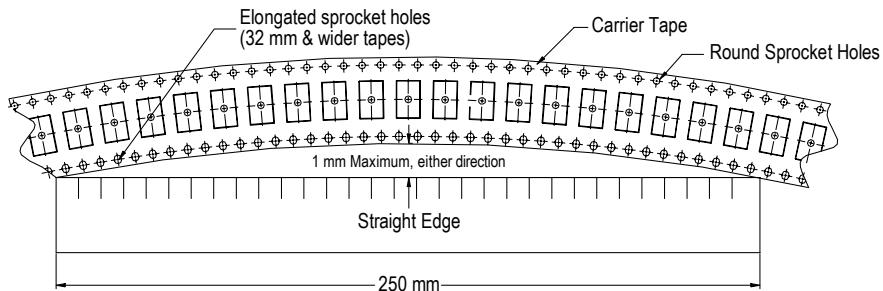
Metric will govern

| Constant Dimensions — Millimeters (Inches) |   |   |  |   |
|--|---|---|--|---|
| Tape Size                                  | A   | B Minimum                                   | C  | D Minimum   |
| 8 mm                                       | $178 \pm 0.20$<br>( $7.008 \pm 0.008$ )<br>or<br>$330 \pm 0.20$<br>( $13.000 \pm 0.008$ ) | 1.5<br>(0.059)                              | $13.0 +0.5/-0.2$<br>( $0.521 +0.02/-0.008$ ) | 20.2<br>(0.795)                                   |
| 12 mm                                      |   |   |  |   |
| 16 mm                                      |   |   |  |   |
| Variable Dimensions — Millimeters (Inches) |   |   |  |   |
| Tape Size                                  | N Minimum   | W <sub>1</sub>                              | W <sub>2</sub> Maximum                       | W <sub>3</sub>                                    |
| 8 mm                                       | 50<br>(1.969)   | $8.4 +1.5/-0.0$<br>( $0.331 +0.059/-0.0$ )  | 14.4<br>(0.567)                              | Shall accommodate tape width without interference |
| 12 mm                                      |   | $12.4 +2.0/-0.0$<br>( $0.488 +0.078/-0.0$ ) | 18.4<br>(0.724)                              |   |
| 16 mm                                      |   | $16.4 +2.0/-0.0$<br>( $0.646 +0.078/-0.0$ ) | 22.4<br>(0.882)                              |   |

## Figure 6 – Tape Leader & Trailer Dimensions



## Figure 7 – Maximum Camber



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